

DECLARATION FOR PATENT APPLICATION

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name, *HS*

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

**FREE STANDING SHAPE MEMORY ALLOY THIN FILM AND
METHOD OF FABRICATION**

specification of which

(Check
one)

is attached hereto



was filed on

July 10, 2001

as

Application Serial No.

09/902,856

and was amended on

(if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the Patent Office all information known to me to be material to patentability as defined in 37 C.F.R. 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Priority Claimed

(Number)	(Country)	(Day/Month/Year Filed)	Yes	No
			<input type="checkbox"/>	<input type="checkbox"/>

(Number)

(Country)

(Day/Month/Year Filed)

Yes

No

I hereby claim the benefit under 35 U.S.C. 119(e) of any United States provisional application(s) listed below.

60/217,664

July 10, 2000

(Provisional Application Number).

(Filing Date)

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose to the Patent Office all information known to me to be material to patentability as defined in 37 C.F.R. 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)

(Filing Date)

(Status)

(patented, pending, abandoned)

(Application Serial No.)

(Filing Date)

(Status)

(patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code, §1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or
first inventor:

A. David Johnson

Inventor's signature:

A. David Johnson

✓

16 Oct 2001

✓

Date:

Residence:

San Leandro, California

Citizenship:

USA

Post Office Address:

1619 Neptune Drive
San Leandro, CA 94577

Full name of sole or
first inventor:

Vikas Galhotra

Inventor's signature:

Vikas Galhotra

✓

October 14, 2001

✓

Date:

Residence:

Union City, California

Citizenship:

INDIA

✓

Post Office Address:

2644 Rainier Ct. Union City, CA
- 94587

✓

Full name of sole or
first inventor:

Vikas Gupta

Vikas Gupta

✓

Inventor's signature:

Vikas Gupta

✓

Date:

Residence:

San Leandro, California

Citizenship:

India

✓

Post Office Address:

238 Lorraine Blvd
San Leandro, CA 94577